

PART LIST

모델명(MODEL NO.): INS-1300F

DESIGN	CHECK	APPR

NO.	부품명 PART NAME	원재료명 MATERIAL NAME	원재료업체 MATERIAL MANUFACTURER	원산지 ORIGIN	도금 PLATING	색상 COLOR	비고 REMARKS
1	TERMINAL	C2680R-EH	POONGSAN METAL CO., LTD.	KOREA	0.2micron		
2	CASE	LCP(VECTRA E130I)	POLYPLASTICS CO.,LTD	JAPAN		Black	T : 0.4mm
3	SPRING PLATE	SUS 301-EH	POONGSAN METAL CO., LTD.	KOREA			150±100gf
4	CLIP	AG/C5210R-EH	CHANG SUNG CORPORATION	KOREA			
5	SLIDE	N46(TW241F6)	DSM ENGINEERING PLASTIC	JAPAN			T:1.5mm
6	COVER	C2680R-EH	POONGSAN METAL CO., LTD.	KOREA	NI+AG		

INNOCENT ELECTRONICS CO., LTD.

1. GENERAL MATTERS

- 1. 1 Application: This specification is applied to low current tactile switch for electronic equipment.
- 1. 2 Operating Temperature Range : -10 $^{\circ}$ C \sim -80 $^{\circ}$ C, 45 \sim 85% RH
- 1. 3 Test Condition : The standard test conditions shall be $5\,^\circ\text{C} \sim 35\,^\circ\text{C}$ in temperature, $45 \sim 85\%$ RH and $860 \sim 1060$ mbar in atmospheric pressure. Should any doubt arise in judgment, tests shall be conducted

at 20 ± 2 °C, 65 ± 5 % RH and 860 \sim 1060mbar.

2. RATED VOLTAGE AND CURRENT

30V DC, 20mA

3. ELECTRICAL PERFORMANCE

	PROPERTY	TEST CONDITION	PERFORMANCE
3. 1	Contact Resistance	Measured at 10mA, 2V DC or by ohmmeter allowing a small current at 1Khz.	70mΩ Max
3. 2	Insulation Resistance	DC 500C is applied between terminals and earth for 1 minute ± 5 seconds.	100MΩ Min
3. 3	Withstand Voltage	250V AC($50\sim60$ HZ) is applied between terminals and earth for 1 minute.	No insulation defect shall be observed.

4. MECHANICAL PERFORMANCE

	PROPERTY	TEST CONDITION	PERFORMANCE
4. 1	Operating Force	A gradually increasing load is applied to the center of the button stem.	As per individual manufactured drawing.
4. 2	Terminal Strength	A static force of 500gf shall be applied to an arbitrary.	Shall be free from terminal looseness, damage and brea- kdown of insulator.
4. 3	Stop Strength	A static force of 3Kgf shall be applied to the direction of operation for 3 seconds.	Shall be free from mechanical and electrical abnormalities.
4. 4	Solder Heat Resistance	Soldering temperature: 245 ~ 255°C soldering time : 10sec.	Shall be free from mechanical and electrical degradation.

5. DURABILITY

	PROPERTY	TEST CONDITION	PERFORMANCE
5. 1	Operating Life	10,000 cycles operations with a load of $500gf$ at a rate of $15 \sim 20 cycles/min$. without load.	Contact resistance 130mΩ Max
			Actuating force : within $\pm 30\%$ of the initial value.

DATE		DESIGNED	CHECKED	APPROVED	PAGE
S/W TYPE	SMD SLIDE S/W				. /
MODEL NO.	INS-1300/1290				
DOCUMENT NO.		/ /	/ /	/ /	/ 3

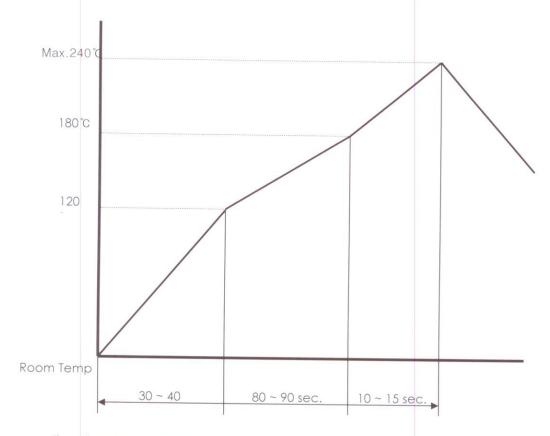
	PROPERTY	TEST CONDITION	PERFORMANCE
5. 1	Resistance to	Following the test set forth below the sample	Item 3. 1
	Low Temperature	shall be left in normal temperature and humidity	Item 3. 2
		conditions for one hour before measurements	Item 3. 3
		are made :	1101110.0
		*temperature/time: -30 ±2°C/96hr	
		*waterdrops shall be removed.	
. 2	Heat Resistance	Following the test set forth below the sample	Item 3. 1
		shall be left in normal temperature and humidity	Item 3. 2
		conditions for one hour before measurements	Item 3. 3
		are made :	110111 0, 0
		*temperature/time: 80 ±2°C/96hr	
5.3	Moisture Resistance	Following the test set forth below the sample	Contact resistance
		shall be left in normal temperature and humidity	200mΩ Max
		conditions for one hour before measurements	Insulation
		are made :	resistance:
		*temperature/time: 80 ±2°C/96hr	10MΩ Min
			Item 3. 3, 3. 4
			Item 4. 1, 4. 5
			110111 4. 1, 4. 0
5. 4	Temperature Cycling	Following 5 cycles of the temperature cycling test	Item 3. 1
		set forth below the sample shall be left in normal	Item 4. 1
		temperature and humidity conditions for one hour	Item 4. 5
		during this test, waterdrops shall be removed.	
		Lovels	
		1 cycle	
		+60℃	
		10°0	
		-10°C	
		2H 1H 2H 1H	
		4	

DATE		DESIGNED	CHECKED	APPROVED	PAGE
S/W TYPE	SMD SLIDE S/W				. /
MODEL NO.	INS-1300/1290				2/
DOCUMENT NO).	/ /	/ /	/ /	/ 3

7. REFLOW SOLDERING

- 7. 1 Refer to the following time temperature chart.

 It is recommended to determine soldering conditions through verification test and on prior agreement of LINK PEACE E.N.G., since surface temperature varies depending upon material, size and thickness PCB.
- 7. 2 Other precautions
 - 1) Switch shall not be washed after soldering with solvent or the like.
 - 2) Soldering shall be controlled so as not to allow flux penetrates switch at its upper face.
 - 3) Switch terminals and PCB upper face shall be free from flux prior to soldering.



Above-mentions time-temperature chart is based on the temperature in the part mounting surface of PCB.

DATE		DESIGN	VED	CHECKED	APPROVED	PAGE
S/W TYPE	SMD SLIDE S/W				_	/
MODEL NO.	INS-1300/1290					3 /
DOCUMENT NO.		/	/	/ /	1 1	/ 3